

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	0	(determine or determining or determined) adj10 (thickness or thicknesses) adj10 conductive adj10 (accept or acceptable or tolerance)	USPAT; US-PGP UB; EPO; JPO; DERWENT; IBM_TD B	2002/09/23 14:33
2	BRS	L2	32449	(deposit or depositing or deposited or deposition) adj10 conductive	USPAT; US-PGP UB; EPO; JPO; DERWENT; IBM_TD B	2002/09/23 14:34
3	BRS	L3	16121	2 same (substrate or substrates or wafer or wafers)	USPAT; US-PGP UB; EPO; JPO; DERWENT; IBM_TD B	2002/09/23 14:34
4	BRS	L5	1	4 same predetermined	USPAT; US-PGP UB; EPO; JPO; DERWENT; IBM_TD B	2002/09/23 14:35
5	BRS	L4	117	3 same (deposition adj3 (recipe or recipes or rate or rates))	USPAT; US-PGP UB; EPO; JPO; DERWENT; IBM_TD B	2002/09/23 14:44

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	2	4 same (measure or measuring or measured)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 14:47
7	BRS	L7	38	(control or controlling or controlled or change or changing or changed or alter or altering or altered) adj10 ((conductive adj10 (deposit or depositing or deposited))) same (thickness or thick or thicknesses or width or widths)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:00

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	7	(control or controlling or controlled or change or changing or changed or alter or altered or altering) same (deposition adj recipe)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:45
2	BRS	L2	9565	thickness same tolerance	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:45
3	BRS	L3	0	2 same deposition	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:45
4	BRS	L4	300	2 same deposition	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:46
5	BRS	L5	300	4 same thickness	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:46

	Type	L #	Hits	Search Text	DBs	Time Stamp
6	BRS	L6	45	5 same conductive	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:57
7	BRS	L7	23	6 same (copper or Cu)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2002/09/23 15:57